



News Release

Unisem Chengdu Co., Ltd. received Supplier Recognition Award Program from SiliconCore Technology Inc.

Kuala Lumpur, 18 August, 2008 – Unisem Chengdu Co., Ltd. ("Unisem Chengdu"), a wholly-owned subsidiary of Unisem (M) Berhad, received the "Supplier Recognition Award Program for 2008" from its valued customer SiliconCore Technology Inc. ("SCT"). SCT is a mixed signal fabless semiconductor company with initial focus on optical semiconductor solution. This award recognizes excellence in overall performance, yield, cycle time, responsiveness and cost of ownership.

Presenting the award to Unisem Chengdu was Mr Eric Li, Chairman and CEO of SCT, "We appreciate the support, flexibility and close cooperation, provided by Unisem this past year. SCT has grown rapidly and we recognize that such growth could only be made possible through the hard work and sacrifices of our employees and suppliers. Together, we were able to win customers such as Sony Japan and Samsung Korea. We urge all of our partners to maintain these efforts as we continue to grow," said Mr Eric Li.

Receiving the award, Unisem Chengdu's President, Chief Operating Officer, Mr KH Tan commented, "SCT is a major user of our probe, assembly and test services in our China factory and we appreciate the opportunity to work with them. We look forward to further developing our relationship with SCT and contributing to its overall growth".

About SCT www.silicon-core.com

SiliconCore(SCT) is a mixed signal fabless semiconductor company with initial focus on optical semiconductor solution. Founded in 1997 as a semiconductor IP and design service company, SCT has been transforming into a product company since 2001. By leverage of the company extensive analog and mixed signal IP, SCT is poised to introduce a suite of high performance mixed signal products into the marketplace. For more information about SCT visit: <http://www.silicon-core.com>.

About Unisem www.unisemgroup.com

Unisem is a global provider of semiconductor assembly and test services for many of the world's most successful electronics companies. Unisem offers an integrated suite of packaging and test services such as wafer bumping, wafer probing, wafer grinding, a wide range of leadframe and substrate IC packaging, wafer level CSP and RF, analog, digital and mixed-signal test services. Our turnkey services include design, assembly, test, failure analysis, and electrical and thermal characterization. With approximately 9,500 employees worldwide, Unisem has factory locations in Ipoh, Malaysia; Wales, United Kingdom; Chengdu, People's Republic of China; Batam, Indonesia and Sunnyvale, USA. The company is headquartered in Kuala Lumpur, Malaysia. For more information about the company, its products and services, please visit its website at www.unisemgroup.com